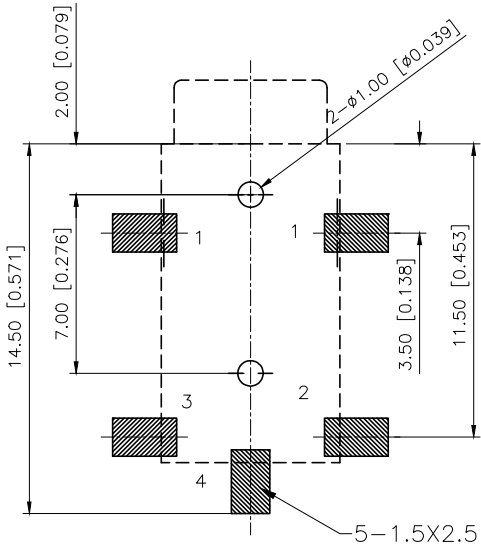
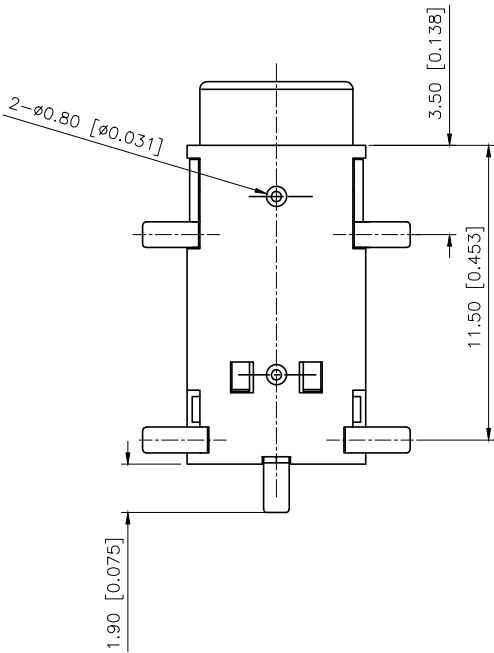
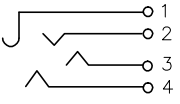
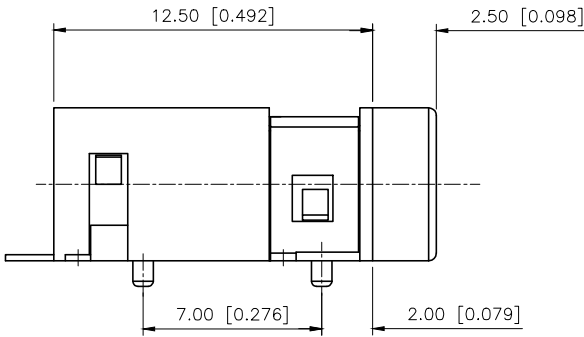
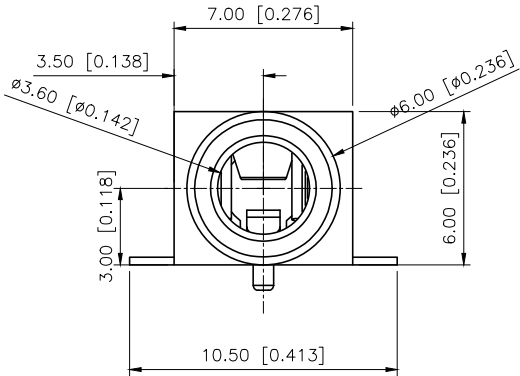


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.06.26	阿树



PCB Layout

Model No.	PJ-322C-SMT
Schematic	



Plastic	High Temp. Thermoplastic	
Terminal 4	Phosphor Bronze	Ag
Terminal 3	Phosphor Bronze	Ag
Terminal 2	Phosphor Bronze	Ag
Terminal 1	Phosphor Bronze	Ag
PAPT NAMF	MATERIAL	PLATING

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	



DESIGN	阿树	VIEW: 	MODEL TYPE: 3.5 PHONE JACK
CHECKED		UNIT: mm/in	PART NO.: PJ-322C-SMT
APPROVED		SIZE: A4	DWG NO.: